

DESCRIPTION

The MOC306x Series are optically coupled isolators consisting of a Gallium Arsenide infrared emitting diode coupled with a monolithic silicon detector performing the functions of a zero crossing bilateral triac mounted in a standard 6 pin dual-in-line package.

FEATURES

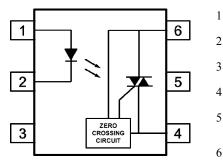
- Zero Voltage Crossing
- Triac Driver Output
- High V_{DRM} minimum 600V
- High Critical Rate of Rise of Off-State Voltage dv/dt minimum 600V/µs
- Isolation Voltage 5000V_{RMS}
- RoHS Compliant
- UL File No. E91231 Package System "TT"
- VDE File No. 40028086

APPLICATIONS

- Solenoid / Valve Controls
- Light Controls
- AC Motor Drivers
- Temperature Controls
- AC Motor Starters
- Solid State Relays

ORDER INFORMATION

- Add Suffix "X" for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel





Anode

- Cathode
- NC
- Main Terminal 1
- 5 Substrate,
- (Do not Connect)
- Main Terminal 2

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$ unless otherwise specified. Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

Input

Forward Current	50mA
Reverse Voltage	6V
Juntion Temperature	125°C
Power dissipation	120mW

Output

Off State Output Terminal Voltage	600V
On State RMS Current	100mA _{RMS}
Peak Repetitive Surge Current (Pulse Width 100µs, 120pps)	1.0A
Junction Temperature	125°C
Power Dissipation	150mW

Total Package

Isolation Voltage	$5000V_{\text{RMS}}$
Total Power Dissipation	250mW
Operating Temperature	-40 to 100°C
Storage Temperature	-55 to 150°C
Lead Soldering Temperature (10s)	260°C

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise specified)

INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Мах	Unit
Forward Voltage	$V_{\rm F}$	$I_{\rm F} = 20 {\rm mA}$		1.2	1.4	V
Reverse Current	I _R	$V_R = 6V$		0.05	10	μA

OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak Off-state Current Either Direction	I _{DRM}	$V_{DRM} = 600V$ $I_F = 0mA$			500	nA
		Note 1				
Peak Blocking Voltage Either Direction	V _{DRM}	$I_{DRM} = 500 nA$	600			V
On-state Voltage Either Direction	V _{TM}	$I_{TM} = 100 \text{mA} \text{ (peak)}$			3.0	V
Critical Rate of Rise of Off-state Voltage (Static dv/dt)	dv/dt	$I_F = 0mA,$ Vin = 240V _{RMS}	1000			V/µs

COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Мах	Unit
Input Trigger Current	I_{FT}	$V_{TM} = 3V$				mA
Either Direction		Note 2				
		MOC3060			30	
		MOC3061			15	
		MOC3062			10	
		MOC3063			5	
Holding Current Either Direction	I _H			400		μA



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

ZERO CROSSING CHARACTERISTICS

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Inhibit Voltage	V _{INH}	I _F = Rated I _{FT} , MT1-MT2 Voltage above which device will not trigger		5	20	V
Leakage Current at Inhibit State	I _{DRM2}	$I_{F} = \text{Rated } I_{FT},$ $V_{DRM} = 600V,$ Off-state			500	μA

ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Isolation Voltage Input-Output	V _{ISO}	RH = 40 to 60%, t = 1 min Note 3	5000			V _{RMS}

Note 1 : Test Voltage must be applied within dv/dt rating.

Note 2 : Guaranteed to trigger at an I_F value less than or equal to max $I_{FT},$ recommended I_F lies between Rated I_{FT} to Absolute Max $I_F.$

Note 3 : Measured with input leads shorted together and output leads shorted together.



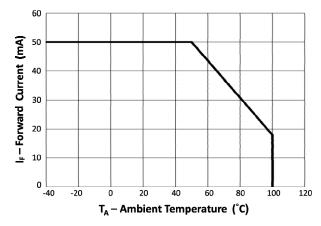


Fig 1 Forward Current vs Ambient Temperature

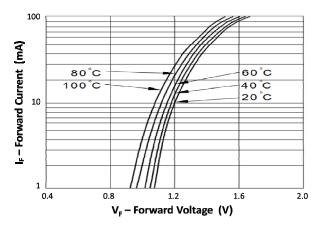
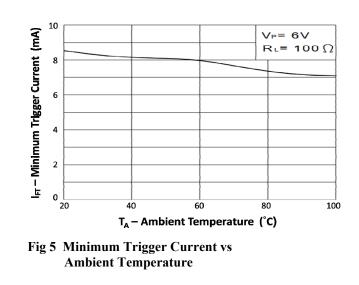


Fig 3 Forward Current vs Forward Voltage



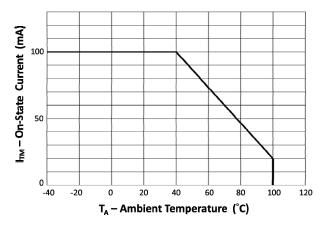


Fig 2 On-State Current vs Ambient Temperature

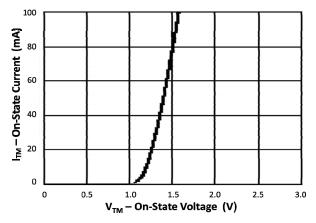


Fig 4 On-state Current vs On-State Voltage

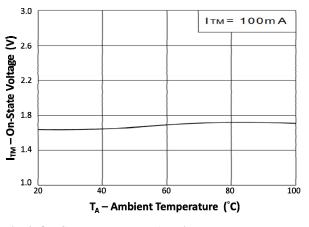
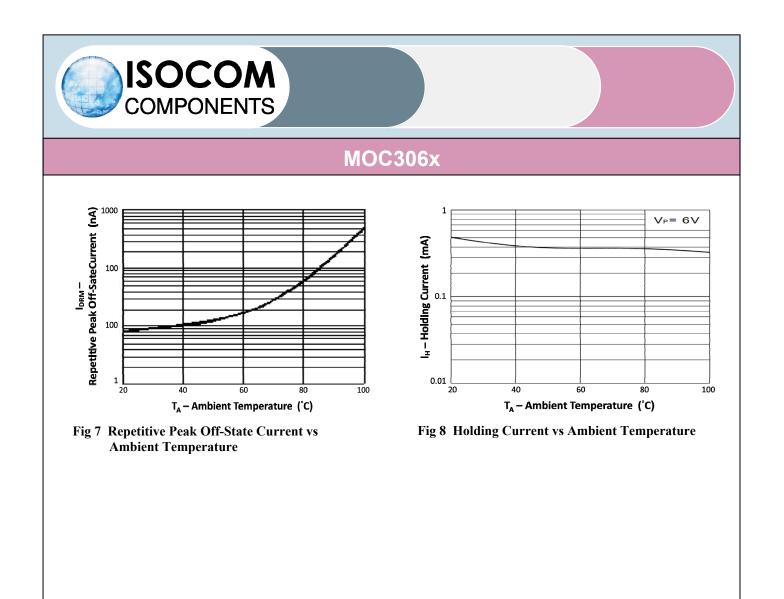


Fig 6 On-State Voltage vs Ambient Temperature





ORDER INFORMATION

MOC306x (UL Approval)					
After PN	PN	Description	Packing quantity		
None	MOC3060, MOC3061, MOC3062, MOC3063	Standard DIP6	65 pcs per tube		
G	MOC3060G, MOC3061G, MOC3062G, MOC3063G	10mm Lead Spacing	65 pcs per tube		
SM	MOC3060SM, MOC3061SM, MOC3062SM, MOC3063SM	Surface Mount	65 pcs per tube		
SMT&R	MOC3060SMT&R, MOC3061SMT&R, MOC3062SMT&R, MOC3063SMT&R	Surface Mount Tape & Reel	1000 pcs per reel		

	MOC306x (UL and VDE Approvals)						
After PN	PN	Description	Packing quantity				
None	MOC3060X, MOC3061X, MOC3062X, MOC3063X	Standard DIP6	65 pcs per tube				
G	MOC3060XG, MOC3061XG, MOC3062XG, MOC3063XG	10mm Lead Spacing	65 pcs per tube				
SM	MOC3060XSM, MOC3061XSM, MOC3062XSM, MOC3063XSM	Surface Mount	65 pcs per tube				
SMT&R	MOC3060XSMT&R, MOC3061XSMT&R, MOC3062XSMT&R, MOC3063XSMT&R	Surface Mount Tape & Reel	1000 pcs per reel				



DEVICE MARKING

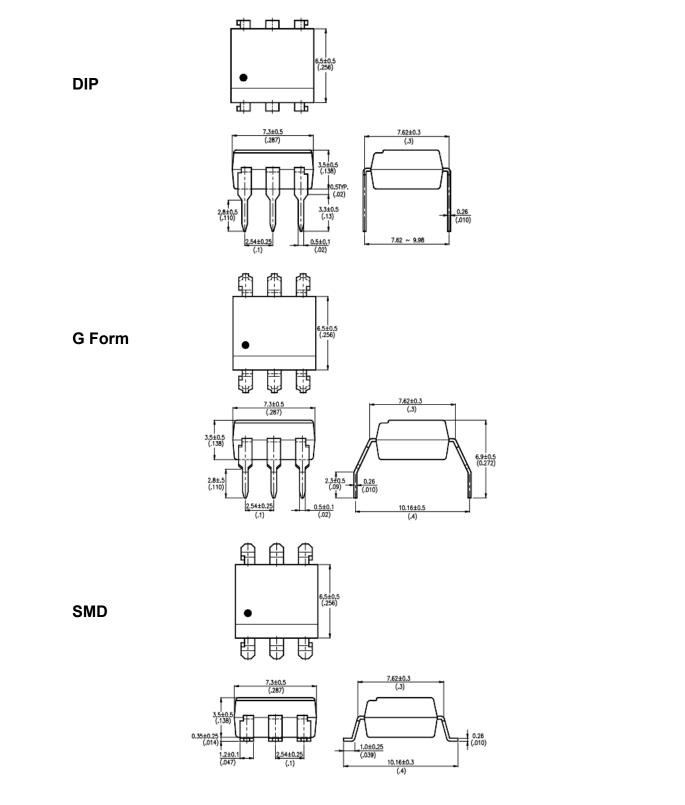
Example : MOC3063X

M	C300	63X
		/ TT
	YWW	

- I denotes Isocom
- Y denotes 2 digit Year code
- WW denotes 2 digit Week code
- TT UL Package System Code

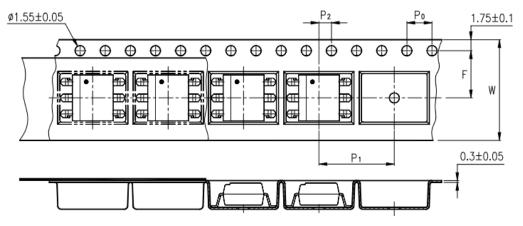


PACKAGE DIMENSIONS in mm (inch)



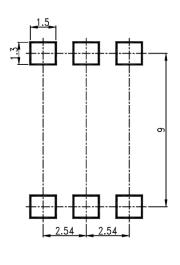


TAPE AND REEL PACKAGING



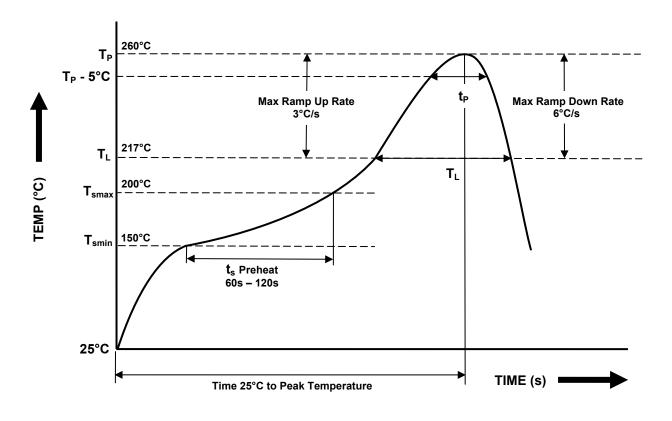
Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	Po	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
	P ₂	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P ₁	12 ± 0.1 (0.47)

RECOMMENDED PAD LAYOUT for SMD (mm)





IR REFLOW SOLDERING TEMPERATURE PROFILE One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
Preheat - Min Temperature (T _{SMIN}) - Max Temperature (T _{SMAX}) - Time T _{SMIN} to T _{SMAX} (t _s)	150°C 200°C 60s - 120s
	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T_{smax} to T_P)	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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 H11L1
 H11L1SM